

# **Description**

The EM01Z is a 200 V, 1.0 A general-purpose rectifier diode with low loss characteristics. This rectifier diode is for a commercial power supply.

### **Features**

•	V <sub>RM</sub>	200 V
•	I <sub>F(AV)</sub>	1.0 A
_	$V_{\rm E} (I_{\rm E} = 1.0 \text{ A})$	0.88 V typ

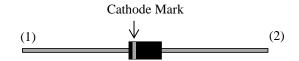
- Bare Leads: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

# **Applications**

- Rectification Circuit
- Reverse Protection Circuit

# **Package**

Axial ( $\varphi$ 2.7 × 5.0L /  $\varphi$ 0.6)





- (1) Cathode
- (2) Anode

Not to scale

## **Absolute Maximum Ratings**

Unless otherwise specified,  $T_A = 25$  °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	$V_{RSM}$		250	V
Repetitive Peak Reverse Voltage	$V_{RM}$		200	V
Average Forward Current	$I_{F(AV)}$	See Figure 2 and Figure 3.	1.0	A
Surge Forward Current	I <sub>FSM</sub>	Half cycle sine wave, positive side, 10 ms, 1 shot	45	A
I <sup>2</sup> t Limiting Value	$I^2t$	$1 \text{ ms} \le t \le 10 \text{ ms}$	10	$A^2s$
Junction Temperature	$T_{J}$		-40 to 150	°C
Storage Temperature	$T_{STG}$		-40 to 150	°C

### **Electrical Characteristics**

Unless otherwise specified,  $T_A = 25$  °C.

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Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage Drop	$V_{\mathrm{F}}$	$I_F = 1.0 A$	_	0.88	0.97	V
Reverse Leakage Current	$I_R$	$V_R = V_{RM}$	_	_	10	μΑ
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 100  ^{\circ}C$	_	_	50	μΑ
Thermal Resistance <sup>(1)</sup>	R <sub>th(J-L)</sub>	See Figure 1.	_	_	20	°C/W

## **Mechanical Characteristics**

Parameter	Conditions	Min.	Тур.	Max.	Unit
Package Weight			0.2		g

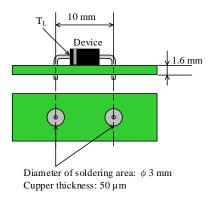
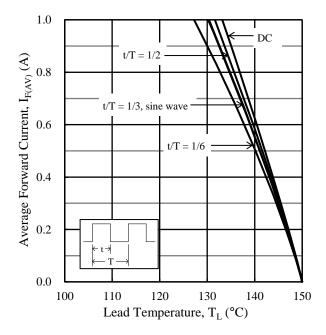
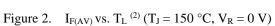


Figure 1. Lead Temperature Measurement Conditions

 $<sup>^{(1)}</sup>R_{th\,(J-L)}$  is thermal resistance between junction and lead. Lead temperature  $(T_L)$  is measured near the root of pin (see Figure 1).

## **Derating Curves**





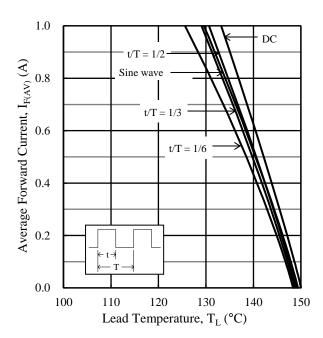
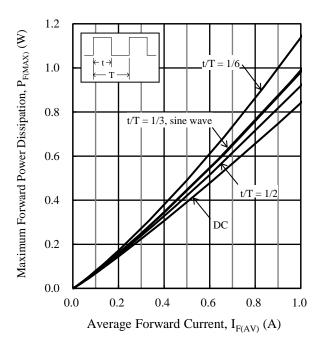


Figure 3.  $I_{F(AV)}$  vs.  $T_L^{(2)}$  ( $T_J = 150$  °C,  $V_R = 200$  V)

<sup>(2)</sup> See Figure 1 for the lead temperature measurement conditions.

### **Characteristic Curves**



 $Figure~4.~~P_{F(MAX)}~vs.~I_{F(AV)}~(T_J=150~^{\circ}C)$ 

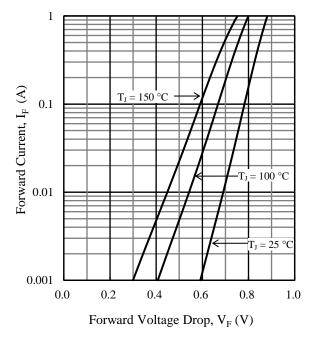


Figure 6. Typical Characteristics: I<sub>F</sub> vs. V<sub>F</sub>

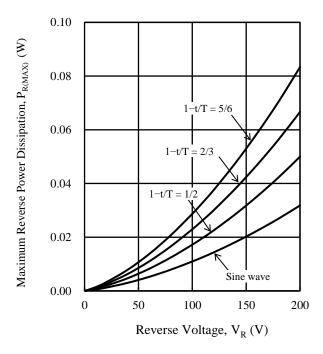


Figure 5.  $P_{R(MAX)}$  vs.  $V_R$  ( $T_J = 150$  °C)

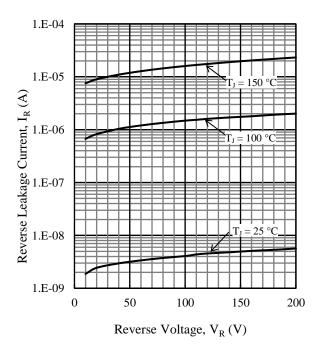


Figure 7. Typical Characteristics: I<sub>R</sub> vs. V<sub>R</sub>

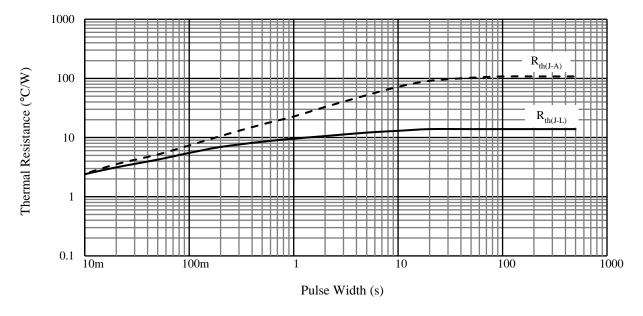
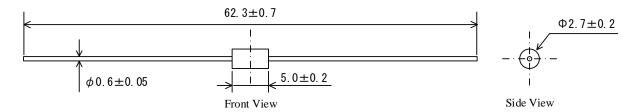


Figure 8. Typical Transient Thermal Resistance Characteristics

## **Physical Dimensions**

• Axial  $(\varphi 2.7 \times 5.0 L / \varphi 0.6)$ 



#### **NOTES:**

- Dimensions in millimeters
- Bare leads: Pb-free (RoHS compliant)
- The total length of the product is the dimension when delivered separately and depends on the taping and lead forming specifications.
- The allowance position of body against the center of the total length of the product is 0.5 mm (max.); see Front View.
- The allowance position of lead against the center of body is 0.2 mm (max.); see Side View.
- The burr may exist up to 2 mm from the body of lead root.
- When soldering the products, it is required to minimize the working time within the following limits:
   Flow: 260 °C / 10 s, 1 time
   Soldering Iron: 350 °C / 3.5 s, 1 time (Soldering should be at a distance of at least 1.5 mm from the body of the product.)

## **Marking Diagram**

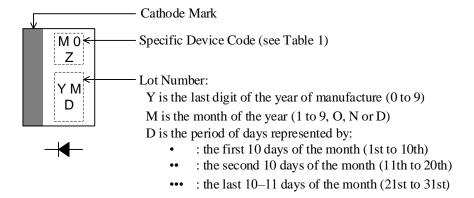


Table 1. Specific Device Code

Specific Device Code	Part Number
M0Z	EM01Z

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DSGN-CEZ-16003